

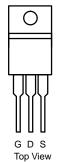
RoHS

COMPLIANT

4N0404-VB TO220 Datasheet N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY		
V _{DS}	40	V
R _{DS(on)} V _{GS} = 10 V	6	mΩ
I _D	110	А
Configuration	Sing	gle

TO-220AB

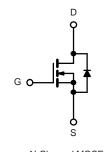


FEATURES

- TrenchFET[®] Power MOSFET
- 100 % $\rm R_g$ and UIS Tested

APPLICATIONS

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<i>/</i> ,	Symbol	Limit	Unit
			40	Unit
Drain-Source Voltage		V _{DS}		V
Gate-Source Voltage		V _{GS}	± 20	
	T _C = 25 °C		110 ^{a, c}	
Continuous Drain Current (T = $175 ^{\circ}$ C)	T _C = 70 °C	1	90 ^c	
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	31 ^b	Α
	T _A = 70 °C		25 ^b	A
Pulsed Drain Current		I _{DM}	270	
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	85	
Single Pulse Avalanche Energy	L = 0.1 IIIH	E _{AS}	320	V
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	110 ^{a, c}	A
Continuous Source-Drain Diode Current	T _A = 25 °C	IS	2.6 ^b	A
	T _C = 25 °C		312 ^a	
Maximum Power Dissipation	T _C = 70 °C	P _D	200	w
	T _A = 25 °C	' D	3.13 ^b	VV
	T _A = 70 °C		2.0 ^b	
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	32	40	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	0.33	0.4	0/11

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		41		~\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 230 \ \mu \Lambda$		- 8		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current		$V_{DS} = 40$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C	10		10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			A	
	Provide	V _{GS} = 10 V, I _D = 30 A		6			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 20 A		7		— mΩ	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		180		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2900			
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		750		pF	
Reverse Transfer Capacitance	C _{rss}			310			
Total Gate Charge	Qg			130		nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		20			
Gate-Drain Charge	Q _{gd}			32			
Gate Resistance	Rg	f = 1 MHz		0.85	1.3	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V _{DD} = 20 V, R _L = 1.0 Ω		11	17	- ns	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_{\text{D}}\cong$ 20 A, V_{GEN} = 10 V, R_{g} = 1 Ω		77	115		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			102	155		
Rise Time	t _r	V_{DD} = 20 V, R_L = 1.0 Ω		62	95		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D} \cong$ 20 A, V_GEN = 4.5 V, R_g = 1 Ω		180	270		
Fall Time	t _f			60	90		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			110	A	
Pulse Diode Forward Current ^a	I _{SM}				200		
Body Diode Voltage	V _{SD}	I _S = 20 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			50	75	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 20 A, di/dt = 100 A/μs, T _J = 25 °C		70	105	nC	
Reverse Recovery Fall Time	t _a	$r_F = 20 \text{ A}, \text{ aval} = 100 \text{ Avps}, r_J = 20 \text{ C}$		30			
Reverse Recovery Rise Time	t _b			20		ns	

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

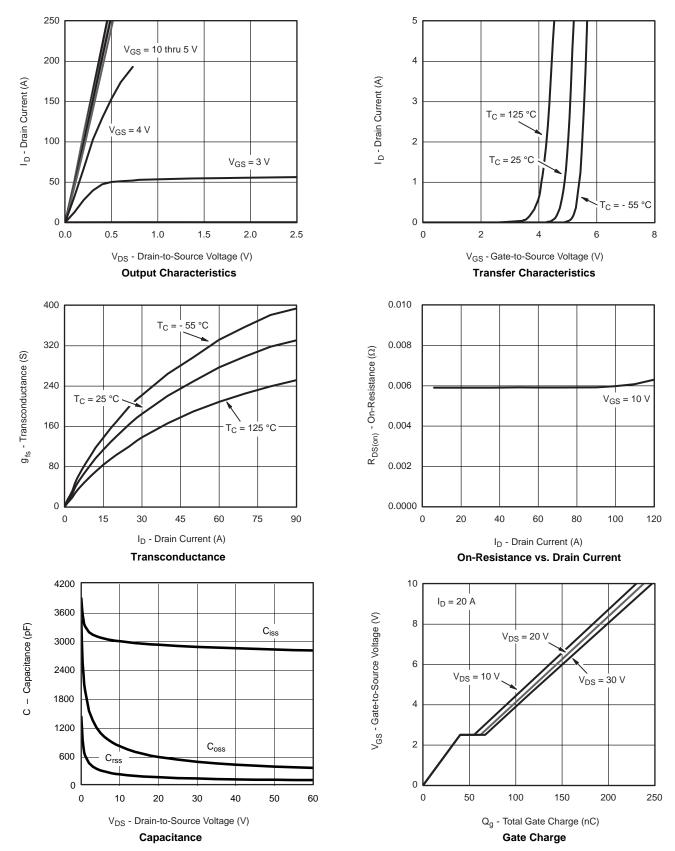
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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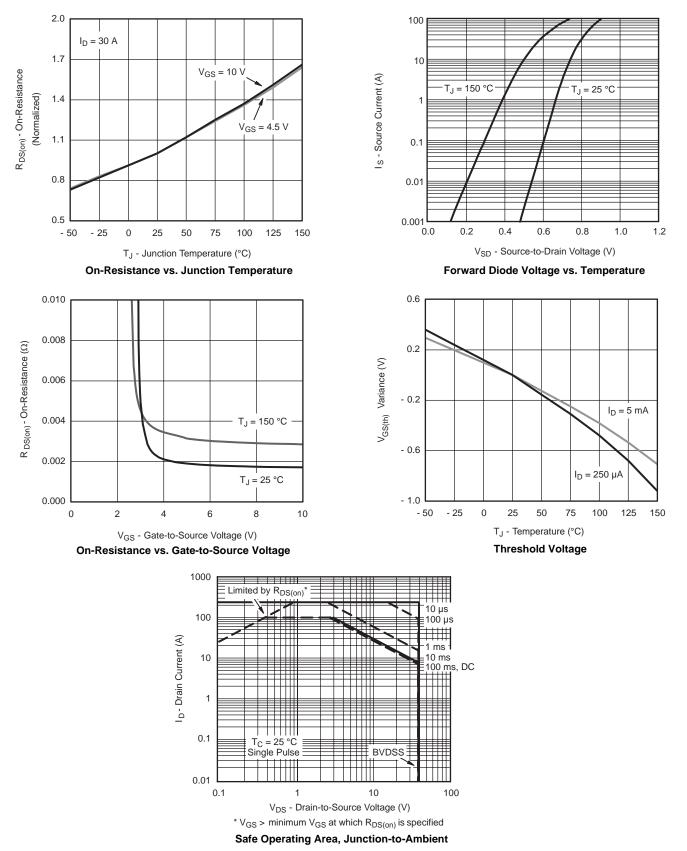
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

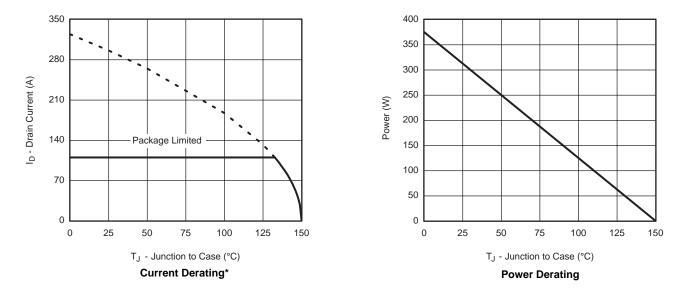


服务热线:400-655-8788



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

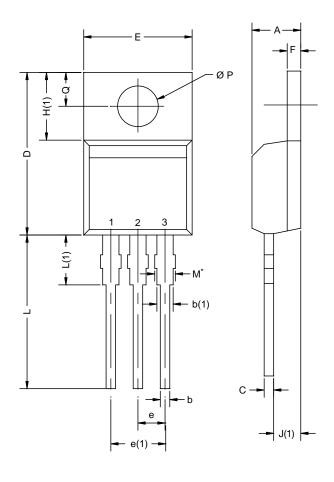


Normalized Thermal Transient Impedance, Junction-to-Case

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TO-220AB



DIM.	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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